## I. <u>AMENDMENTS TO THE SPECIFICATION</u>

Page 3, line 7, replace "1-phenyl-3-parazolidinone" with --1-phenyl-3-pyrazolidinone--;

## II. AMENDMENTS TO THE CLAIMS

The following amendments are requested according to the revised format as set forth in 1267 OG 106 (Feb. 25, 2003). Deleted matter is indicated by strike-out text and added matter is indicated by underlined text.

Claim 1 (currently amended) An electroplating solution for plating tin-copper alloy solder coatings comprising:

a sulfonic acid electrolyte;

a tin compound soluble in the sulfonic acid to form a tin sulfonate;

a copper compound soluble in the sulfonic acid to form a copper sulfonate;

a non-ionic surfactant;

a satin brightener <u>comprising an aromatic amine</u>, a tertiary amine, or oxidized 1phenyl-3-pyrazolidione; and

an antioxidant.

Claim 7 (currently amended) The electroplating solution of claim 1 wherein the non-ionic surfactant comprises polyoxyethlenepolyoxyethylene-block-polyoxypropylene with molecular weight between 2000 and 10,000.

Claims 8-9 (canceled).